

Resolution Plot

DESIGN MSX40

Wafer No.: **2403-20**

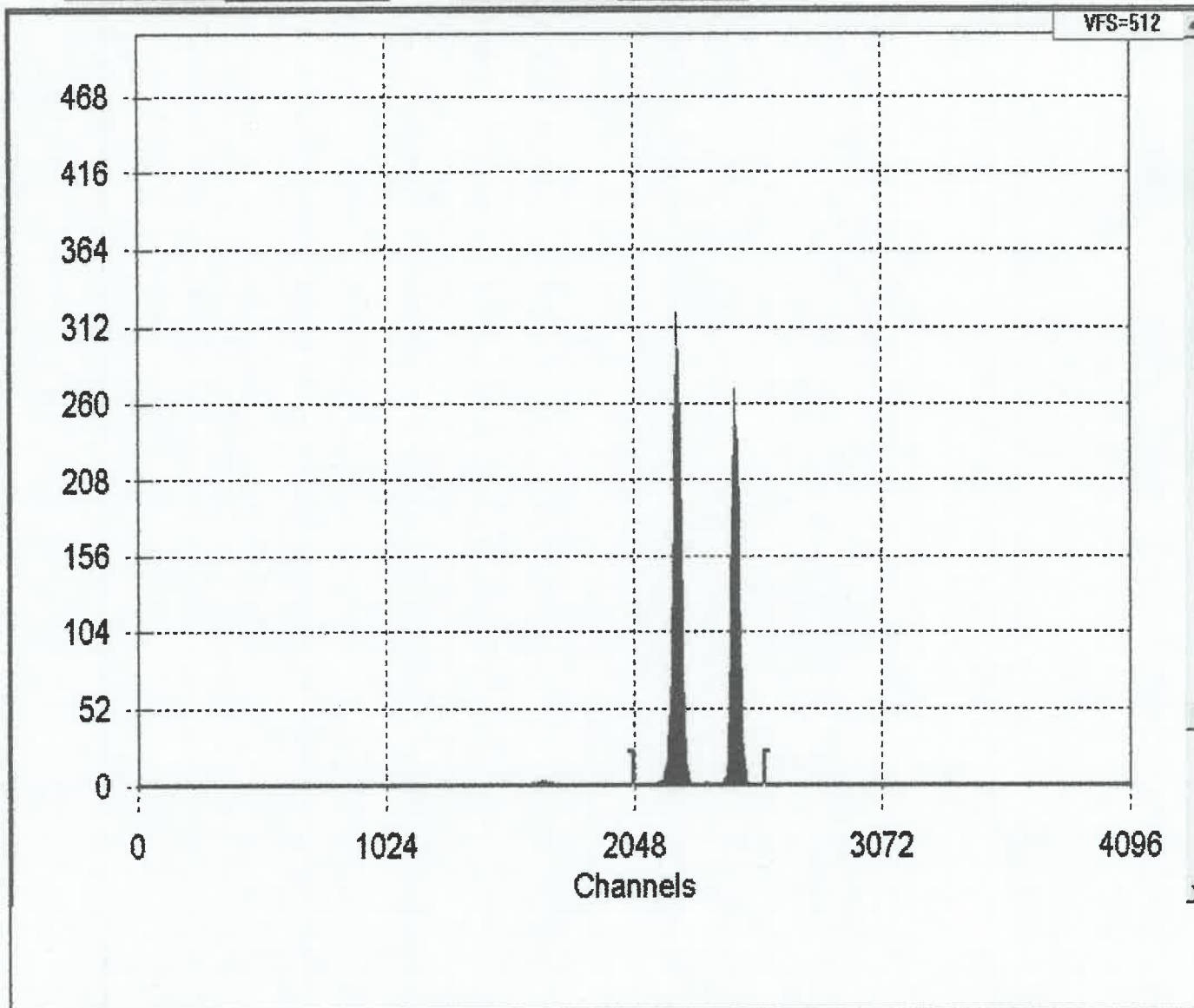
Thickness: **1528** um

JUNCTION

DET LINE: **75.1** KeV
SYSTEM: **66** KeV
CAL: **35.8** KeV

OHMIC

DET LINE: **78.3** KeV
SYSTEM: **66** KeV
CALC: **42.1** KeV



Source
Am 241

Rise Time
1

Flat Top
0

MICRON SEMICONDUCTOR LTD

02 AUG 2005

QUALITY CONTROL
QUALITY OFFICER
SIGNATURE

APPROVED

BIAS VOLTS= **290** V

Leakage **1200** nA

Micron Semiconductor
11/07/2005